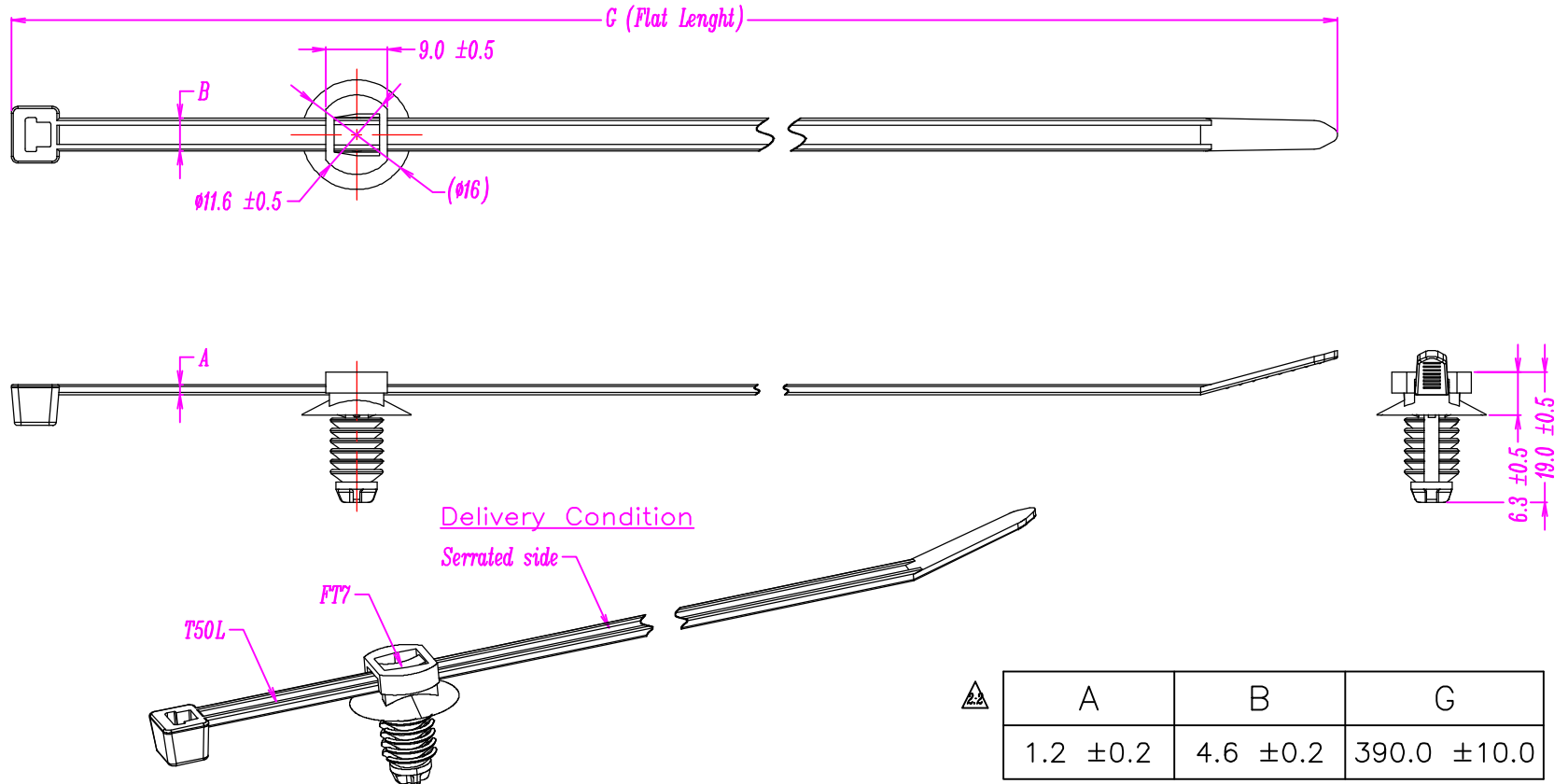


Revision Level		Revision Record	Changed	Date	Approval	Date
Part	Drawing					
	1	Remove bundle diameter.	Mandy Ong	28-Jan-09	Edward Tan	28-Jan-09
	2	Updated pictogramme and drawing template.	SIMON NG	06-Aug-19	Edward Tan	06-Aug-19
	2.1	Added HT Global project Number.	SIMON NG	06-Aug-19	Edward Tan	06-Aug-19
	2.2	Remove "D", "E" and "H" from cable tie dimensions chart.	SIMON NG	06-Aug-19	Edward Tan	06-Aug-19



Hole Size :
 $\phi 6.5 \sim \phi 7.0\text{mm}$

Panel Thickness :
 $0.8 \sim 7.0\text{mm}$

Material
P.A. 66

Tensile strength
225N (Minimum)

PERFORMANCE
SPECIFICATION

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	Approved. EDWARD TAN 30 April 2007	Title T50LFT7	
545, Yishun Industrial Park A Yishun Avenue 7 Singapore 768741 Tel: (+65) 6852 8585 Fax: (+65) 6756 6798	Drawing-No [SG07023-02] 18-0898-001-CSH		Format A4 Sheet 1 of 1

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